

FCP7N60N / FCPF7N60NT N-Channel MOSFET 600V, 6.8A, 0.52Ω

Features

- $R_{DS(on)} = 0.46\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 3.4A$
- Ultra Low Gate Charge (Typ.Qg = 17.8nC)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- RoHS Compliant



December 2009 SupreMOSTM

Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter	FCP7N60N	FCPF7N60NT	Units
V _{DSS}	Drain to Source Voltage			600	
V _{GSS}	Gate to Source Voltage			±30	
I _D	Drain Current	-Continuous (T _C = 25 ^o C)	6.8	6.8*	А
		-Continuous (T _C = 100 ^o C)	4.3	4.3*	A
I _{DM}	Drain Current	- Pulsed (Note 1) 20.4	20.4	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		79.4		mJ
I _{AR}	Avalanche Current			6.8	
E _{AR}	Repetitive Avalanche Energy			0.6	
dv/dt	MOSFET dv/dt Ruggedness			100	
	Peak Diode Recovery dv/dt (Note 3)		4.9		V/ns
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$	64.1	30.5	W
		- Derate above 25°C	0.51	0.24	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	
Drain current lir	mited by maximum junction temperatu	re			

Thermal Characteristics

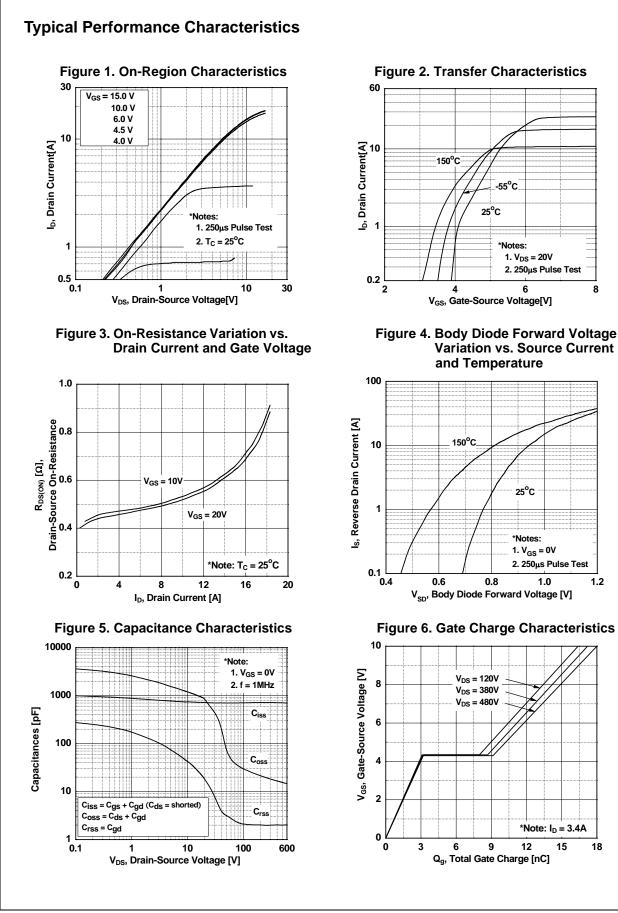
Symbol	Parameter	FCP7N60N	FCPF7N60NT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.95	4.1	
$R_{\theta CS}$	Thermal Resistance, Case to Heak Sink (Typical)	0.5	0.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

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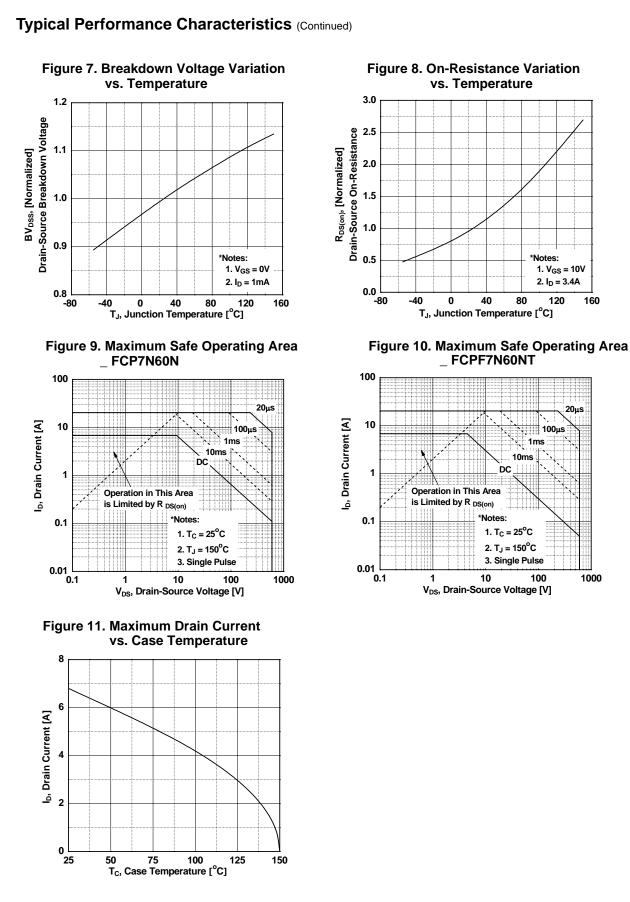
FCP7NA	FCP7N60N FCP7N60N TO-22		Package	Reel Size	Таре	e Width		Quantit	у	
			TO-220AB	-		-		50		
FCPF7N6			TO-220F	-		-		50		
Electrica	I Char	acteristics T _c =	= 25ºC unless ot	herwise noted						
Symbol		Parameter		Test Conditions	st Conditions Min.		Тур.	Max.	Units	
Off Charac	teristic	s								
BV _{DSS}	Drain to	n to Source Breakdown Voltage		$I_D = 1mA, V_{GS} = 0V, T_C = 25^{\circ}C$		600	-	-	V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient		ure	$I_D = 1$ mA, Referenced to 25°C		-	0.6	-	V/ºC	
	Zoro Gr			$V_{\rm DS} = 480 \text{V}, \text{ V}_{\rm GS} = 0 \text{V}$		-	-	10		
DSS	Zero Gate Voltage Drain Current		۱	$V_{\rm DS} = 480 \text{V}, \text{ V}_{\rm GS} = 0 \text{V}, \text{ T}_{\rm C}$	= 125°C	-	-	100	μA	
I _{GSS}	Gate to Body Leakage Current		nt \	$V_{\rm GS} = \pm 30 \text{V}, \text{V}_{\rm DS} = 0 \text{V}$		-	-	±100	nA	
On Charac	teristic	S								
V _{GS(th)}	Gate Th	reshold Voltage	١	/ _{GS} = V _{DS} , I _D = 250μA		2.0	-	4.0	V	
R _{DS(on)}	Static D	rain to Source On Res	sistance	/ _{GS} = 10V, I _D = 3.4A		-	0.46	0.52	Ω	
9 _{FS}	Forward	ard Transconductance		$I_{\rm DS} = 20 V, I_{\rm D} = 3.4 A$		-	8.5	-	S	
Dynamic C	haracte	eristics								
C _{iss}	Input Ca	Input Capacitance Output Capacitance Reverse Transfer Capacitance		V _{DS} = 100V, V _{GS} = 0V f = 1MHz		-	719	960	pF	
C _{oss}	-					-	30	40	pF	
C _{rss}	-					-	2.1	3.2	pF	
C _{oss}		t Capacitance		/ _{DS} = 380V, V _{GS} = 0V, f =	1MHz	-	17	-	pF	
C _{oss} eff	-	ve Output Capacitance		$V_{DS} = 0V$ to 380V, $V_{GS} = 0V$		-	91	-	pF	
Q _{g(tot)}	Total Ga	Gate Charge at 10V		$I_{\rm DS} = 380 \text{V}, I_{\rm D} = 3.4 \text{A}$		-	17.8	35.6	nC	
Q _{gs}		Source Gate Charge		$V_{GS} = 10V$		-	3.2	6.3	nC	
Q _{gd}	Gate to	to Drain "Miller" Charge		(Note 4)		-	6.0	11.9	nC	
ESR	Equivale	quivalent Series Resistance (G-S)		Drain Open		-	2.5	-	Ω	
Switching	Charac	teristics								
t _{d(on)}	Turn-On Delay Time					-	12	24	ns	
t _r	Turn-On	Rise Time		/ _{DD} = 380V, I _D = 3.4A	-	-	6	22	ns	
t _{d(off)}	Turn-Off	f Delay Time	F	$R_{G} = 4.7\Omega$		-	35	80	ns	
t _f		f Fall Time			(Note 4)	-	12	24	ns	
Drain-Sou	rce Dioc	de Characteristic	S							
I _S	Maximu	m Continuous Drain to	Source Diode F	Forward Current		-	-	6.8	Α	
I _{SM}	Maximu	m Pulsed Drain to Sou	urce Diode Forw	orward Current		-	-	20.4	А	
0.01	Drain to	Source Diode Forwar	d Voltage	$V_{GS} = 0V, I_{SD} = 3.4A$		-	-	1.2	V	
V _{SD}	Reverse	Recovery Time	١	/ _{GS} = 0V, I _{SD} = 3.4A		-	211	-	ns	
		Recovery Charge	$dI_F/dt = 100A/\mu s$		-	1.8	-	μC		

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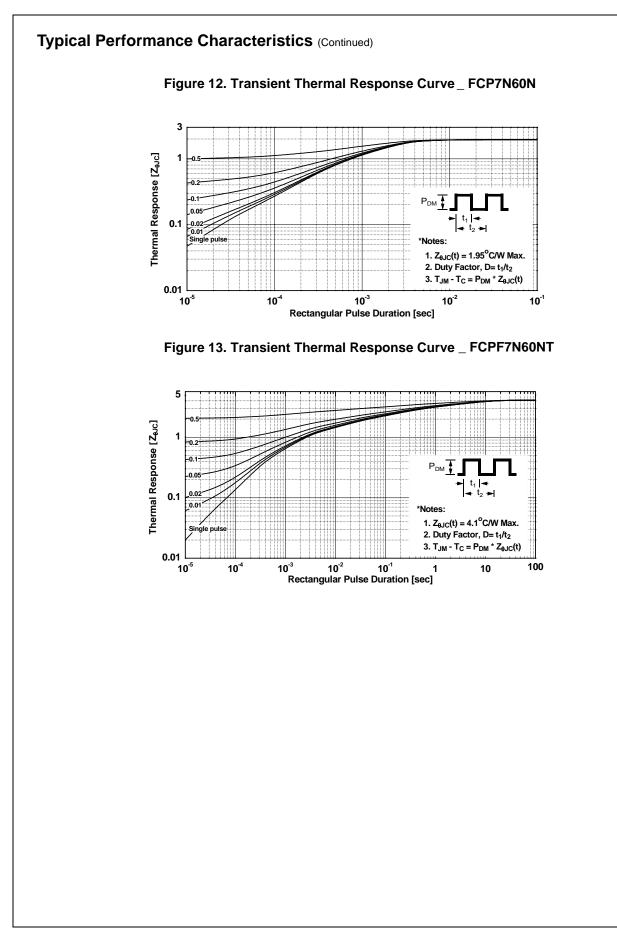




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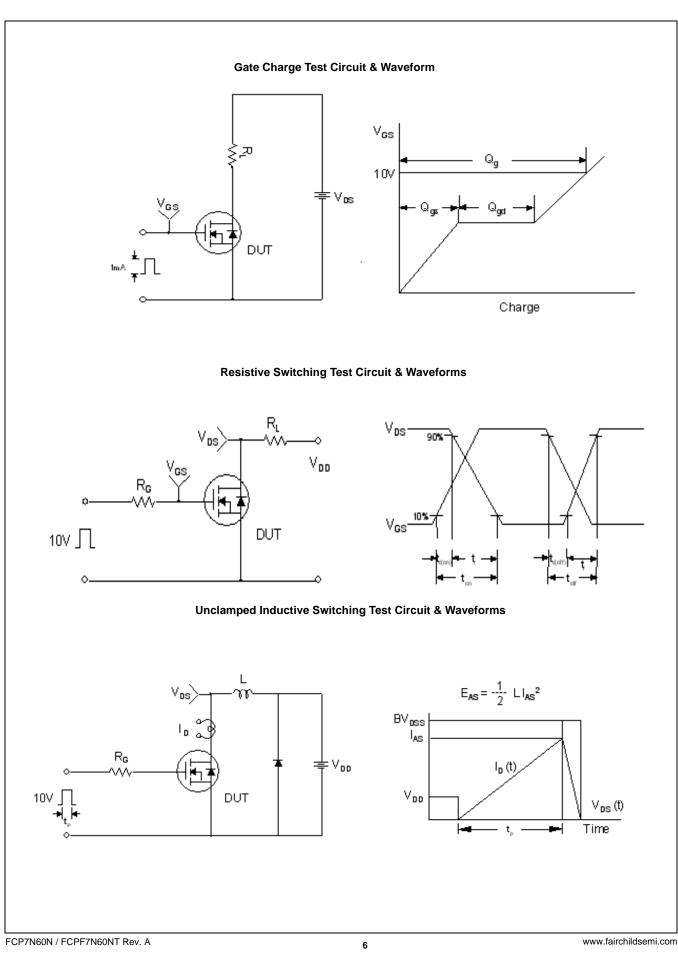


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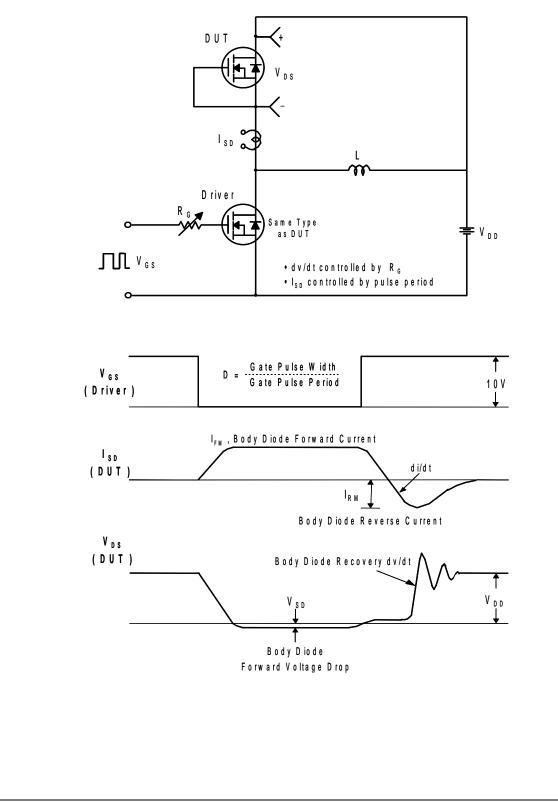
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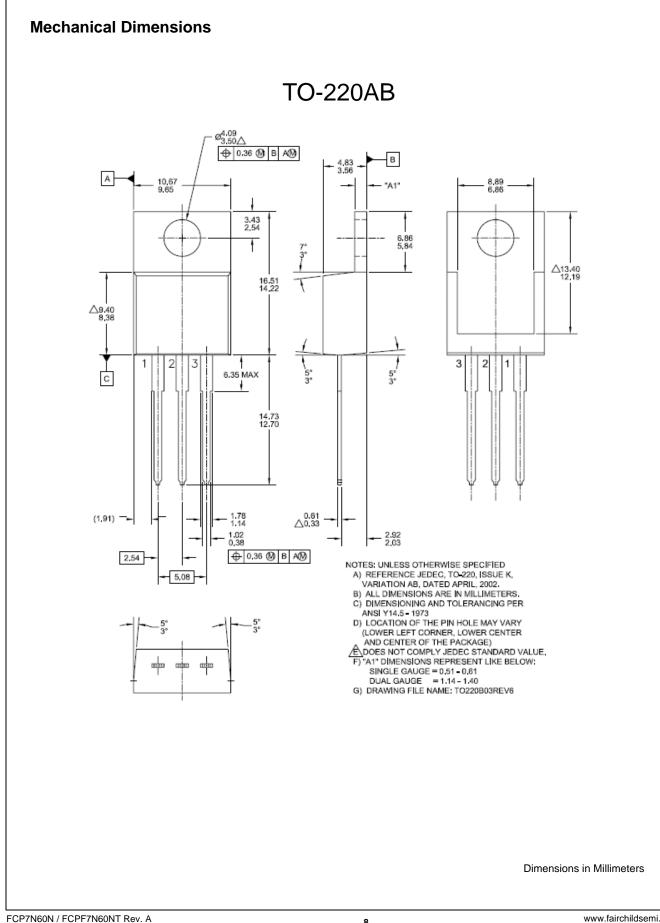


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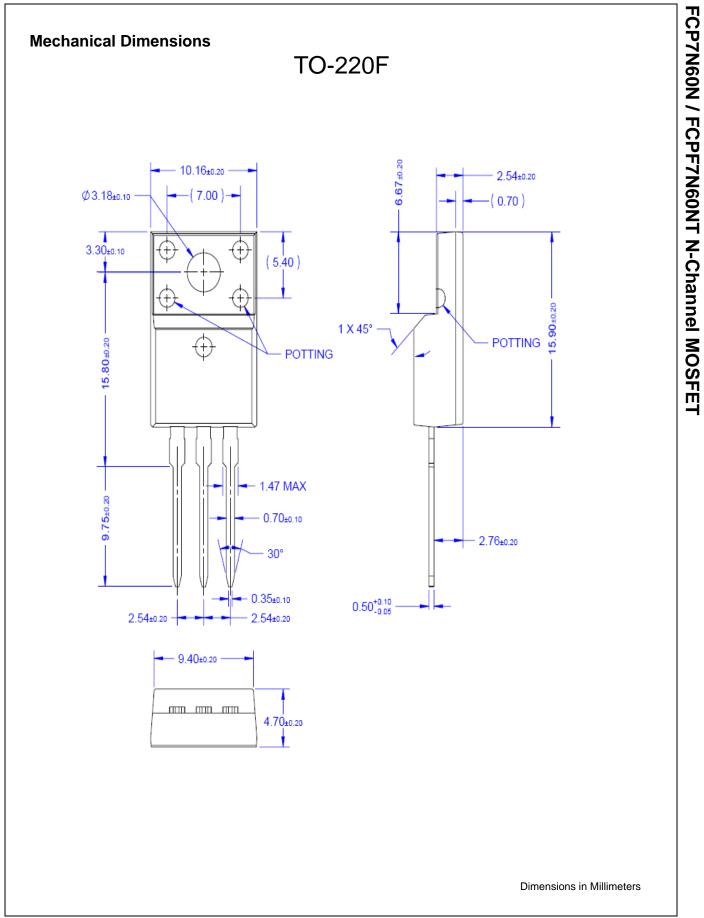


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8

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FCP7N60N / FCPF7N60NT Rev. A



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